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Kind regards,

Team Nexperia

74LVC245A; 74LVCH245A

Octal bus transceiver; 3-state
Rev. 8 — 28 June 2013

Product data sheet

General description 1.

The 74LVC245A; 74LVCH245A are 8-bit transceivers featuring non-inverting 3-state bus compatible outputs in both send and receive directions. The device features an output enable (OE) input for easy cascading and a send/receive (DIR) input for direction control. OE controls the outputs so that the buses are effectively isolated.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

The 74LVCH245A bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

2. **Features and benefits**

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- Direct interface with TTL levels
- Inputs accept voltages up to 5.5 V
- High-impedance when V_{CC} = 0 V
- Bus hold on all data inputs (74LVCH245A only)
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ♦ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

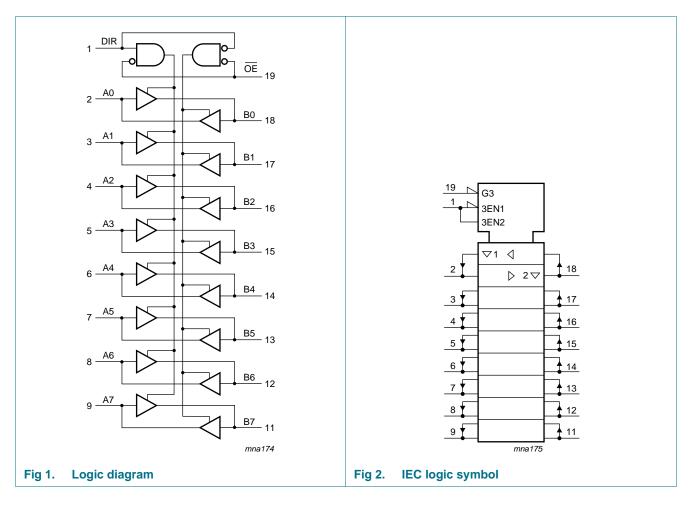


3. Ordering information

Table 1. Ordering information

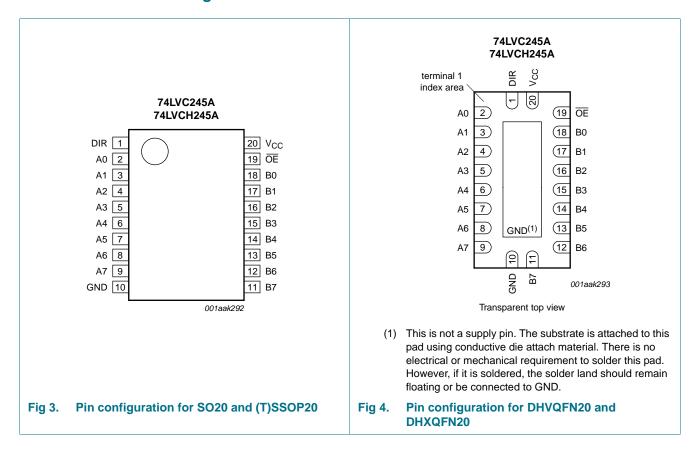
| Type number | Package | | | | | | | | | | | |
|--------------|-------------------|----------|---|-----------|--|--|--|--|--|--|--|--|
| | Temperature range | Name | Description | Version | | | | | | | | |
| 74LVC245AD | –40 °C to +125 °C | SO20 | plastic small outline package; 20 leads; | SOT163-1 | | | | | | | | |
| 74LVCH245AD | | | body width 7.5 mm | | | | | | | | | |
| 74LVC245ADB | –40 °C to +125 °C | SSOP20 | plastic shrink small outline package; 20 leads; | SOT339-1 | | | | | | | | |
| 74LVCH245ADB | | | body width 5.3 mm | | | | | | | | | |
| 74LVC245APW | –40 °C to +125 °C | TSSOP20 | plastic thin shrink small outline package; 20 leads; | SOT360-1 | | | | | | | | |
| 74LVCH245APW | | | body width 4.4 mm | | | | | | | | | |
| 74LVC245ABQ | –40 °C to +125 °C | DHVQFN20 | plastic dual in-line compatible thermal enhanced | SOT764-1 | | | | | | | | |
| 74LVCH245ABQ | | | very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm | | | | | | | | | |
| 74LVC245ABX | –40 °C to +125 °C | DHXQFN20 | plastic dual in-line compatible thermal enhanced | SOT1045-2 | | | | | | | | |
| 74LVCH245ABX | _ | | extremely thin quad flat package; no leads; 20 terminals; body $4.5 \times 2.5 \times 0.5$ mm | | | | | | | | | |

4. Functional diagram



5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

| | The second secon | |
|----------|--|----------------------------------|
| Symbol | Pin | Description |
| DIR | 1 | direction control |
| A0 to A7 | 2, 3, 4, 5, 6, 7, 8, 9 | data input/output |
| GND | 10 | ground (0 V) |
| B0 to B7 | 18, 17, 16, 15, 14, 13, 12, 11 | data input/output |
| OE | 19 | output enable input (active LOW) |
| V_{CC} | 20 | supply voltage |
| | | |

6. Functional description

Table 3. Function selection[1]

| Inputs | | Inputs/outputs | | | | |
|--------|-----|----------------|---------|--|--|--|
| OE | DIR | An | Bn | | | |
| L | L | An = Bn | inputs | | | |
| L | Н | inputs | Bn = An | | | |
| Н | X | Z | Z | | | |

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high impedance OFF-state.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|--|---------------------|----------------|------|
| V_{CC} | supply voltage | | -0.5 | +6.5 | V |
| I _{IK} | input clamping current | V _I < 0 V | -50 | - | mA |
| V_{I} | input voltage | | <u>[1]</u> –0.5 | +6.5 | V |
| I _{OK} | output clamping current | $V_O > V_{CC}$ or $V_O < 0 V$ | - | ±50 | mA |
| V _O | output voltage | output HIGH or LOW | <u>[2]</u> –0.5 | $V_{CC} + 0.5$ | V |
| | | output 3-state | ^[2] -0.5 | +6.5 | V |
| Io | output current | $V_O = 0 V \text{ to } V_{CC}$ | - | ±50 | mA |
| I _{CC} | supply current | | - | 100 | mA |
| I_{GND} | ground current | | -100 | - | mA |
| T _{stg} | storage temperature | | - 65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$ | [3] _ | 500 | mW |

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] For SO20 packages: above 70 °C derate linearly with 8 mW/K.
For (T)SSOP20 packages: above 60 °C derate linearly with 5.5 mW/K.
For DHVQFN20 and DHXQFN20 packages: above 60 °C derate linearly with 4.5 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|-------------------------------------|--|------|-----|----------|------|
| V_{CC} | supply voltage | | 1.65 | - | 3.6 | V |
| | | functional | 1.2 | - | 3.6 | V |
| VI | input voltage | | 0 | - | 5.5 | V |
| Vo | output voltage | output HIGH or LOW | 0 | - | V_{CC} | V |
| | | output 3-state | 0 | - | 5.5 | V |
| T _{amb} | ambient temperature | in free air | -40 | - | +125 | °C |
| Δt/ΔV | input transition rise and fall rate | $V_{CC} = 1.2 \text{ V to } 2.7 \text{ V}$ | 0 | - | 20 | ns/V |
| | | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | 0 | - | 10 | ns/V |

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -40 | °C to + | 85 °C | –40 °C to | +125 °C | Unit |
|-------------------|--|---|------------------------|---------|-----------------------|----------------------|----------------------|------|
| | | | Min | Typ[1] | Max | Min | Max | |
| V _{IH} | HIGH-level | V _{CC} = 1.2 V | 1.08 | - | - | 1.08 | - | V |
| | input voltage | V _{CC} = 1.65 V to 1.95 V | 0.65 × V _{CC} | - | - | $0.65 \times V_{CC}$ | - | V |
| | | V _{CC} = 2.3 V to 2.7 V | 1.7 | - | - | 1.7 | - | V |
| | | V _{CC} = 2.7 V to 3.6 V | 2.0 | - | - | 2.0 | - | V |
| V _{IL} | LOW-level | V _{CC} = 1.2 V | - | - | 0.12 | - | 0.12 | V |
| | input voltage | V _{CC} = 1.65 V to 1.95 V | - | - | $0.35 \times V_{CC}$ | - | $0.35 \times V_{CC}$ | V |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | - | - | 0.7 | - | 0.7 | V |
| | | V _{CC} = 2.7 V to 3.6 V | - | - | 0.8 | - | 0.8 | V |
| V _{OH} | HIGH-level | $V_I = V_{IH}$ or V_{IL} | | | | | | |
| output voltage | $I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$ | V _{CC} - 0.2 | - | - | V _{CC} – 0.3 | - | V | |
| | | $I_O = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.2 | - | - | 1.05 | - | V |
| | | $I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.8 | - | - | 1.65 | - | V |
| | | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | 2.2 | - | - | 2.05 | - | V |
| | | $I_O = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.4 | - | - | 2.25 | - | V |
| | | $I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.2 | - | - | 2.0 | - | V |
| V _{OL} | LOW-level | $V_I = V_{IH}$ or V_{IL} | | | | | | |
| | output voltage | $I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$ | - | - | 0.2 | - | 0.3 | V |
| | | $I_O = 4 \text{ mA}$; $V_{CC} = 1.65 \text{ V}$ | - | - | 0.45 | - | 0.65 | V |
| | | $I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.6 | - | 0.8 | V |
| | | $I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | - | - | 0.4 | - | 0.6 | V |
| | | $I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.55 | - | 0.8 | V |
| I _I | input leakage current | $V_1 = 5.5 \text{ V or GND};$ $V_{CC} = 3.6 \text{ V}$ | 2] - | ±0.1 | ±5 | - | ±20 | μА |

74LVC_LVCH245A

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Table 6. Static characteristics ... continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -40 | 0 °C to +85 | o °C | -40 °C to | +125 °C | Unit | |
|-------------------|---------------------------------|--|--------|-------------|--------|-----------|---------|------|----|
| | | | | Min | Typ[1] | Max | Min | Max | |
| l _{OZ} | OFF-state output current | $V_I = V_{IH}$ or V_{IL} ; $V_O = 5.5$ V or GND; $V_{CC} = 3.6$ V | [3] | - | ±0.1 | ±5 | - | ±20 | μА |
| I _{OFF} | power-off leakage current | V_{I} or V_{O} = 5.5 V; V_{CC} = 0.0 V | | - | ±0.1 | ±10 | - | ±20 | μΑ |
| I _{CC} | supply current | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 3.6 \text{ V}$ | | - | 0.1 | 10 | - | 40 | μΑ |
| Δl _{CC} | additional supply current | per input pin; $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | | - | 5 | 500 | - | 5000 | μА |
| Cı | input capacitance | $V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$ | | - | 4.0 | - | - | - | pF |
| C _{I/O} | input/output capacitance | $V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$ | | - | 10 | - | - | - | pF |
| I _{BHL} | bus hold | $V_{CC} = 1.65; V_I = 0.58 V$ | [4][5] | 10 | - | - | 10 | - | μΑ |
| | LOW current | $V_{CC} = 2.3; V_I = 0.7 V$ | | 30 | - | - | 25 | - | μΑ |
| | | $V_{CC} = 3.0$; $V_I = 0.8 \text{ V}$ | | 75 | - | - | 60 | - | μΑ |
| I _{BHH} | bus hold | $V_{CC} = 1.65; V_I = 1.07 V$ | [4][5] | -10 | - | - | -10 | - | μΑ |
| | HIGH current | $V_{CC} = 2.3; V_I = 1.7 V$ | | -30 | - | - | -25 | - | μΑ |
| | | $V_{CC} = 3.0; V_I = 2.0 V$ | | -75 | - | - | -60 | - | μΑ |
| I _{BHLO} | bus hold | V _{CC} = 1.95 V | | 200 | - | - | 200 | - | μΑ |
| | LOW | V _{CC} = 2.7 V | | 300 | - | - | 300 | - | μΑ |
| | overdrive current | V _{CC} = 3.6 V | [4][6] | 500 | - | - | 500 | - | μΑ |
| I _{BHHO} | bus hold | V _{CC} = 1.95 V | | -200 | - | - | -200 | - | μΑ |
| | HIGH | V _{CC} = 2.7 V | | -300 | - | - | -300 | - | μΑ |
| | overdrive current | V _{CC} = 3.6 V | [4][6] | -500 | - | - | -500 | - | μΑ |

^[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

^[2] The bus hold circuit is switched off when $V_I > V_{CC}$ allowing 5.5 V on the input terminal.

^[3] For I/O ports the parameter I_{OZ} includes the input leakage current.

^[4] Valid for data inputs of bus hold parts only (74LVCH245A). Note that control inputs do not have a bus hold circuit.

^[5] The specified sustaining current at the data input holds the input below the specified V_I level.

^[6] The specified overdrive current at the data input forces the data input to the opposite input state.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

| Symbol | Parameter | Conditions | | -40 | °C to +8 | 5 °C | -40 °C to | +125 °C | Unit |
|--------------------|-------------------------|--|------------|-----|----------|------|-----------|---------|------|
| | | | | Min | Typ[2] | Max | Min | Max | |
| t _{pd} | propagation | nAn to nBn; nBn to nAn; see Figure 5 | [1] | | | | | ' | |
| | delay | V _{CC} = 1.2 V | | - | 17.0 | - | - | - | ns |
| | | V _{CC} = 1.65 V to 1.95 V | | 1.5 | 6.5 | 14.6 | 1.5 | 16.9 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 1.0 | 3.4 | 7.6 | 1.0 | 8.7 | ns |
| | | V _{CC} = 2.7 V | | 1.5 | 3.4 | 7.3 | 1.5 | 9.5 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.5 | 2.9 | 6.3 | 1.5 | 8.0 | ns |
| t _{en} | enable time | nOE to nAn, nBn; see Figure 6 | [1] | | | | | | |
| | | $V_{CC} = 1.2 \text{ V}$ | | - | 22.0 | - | - | - | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 1.9 | 8.3 | 19.5 | 1.9 | 22.5 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 1.5 | 4.6 | 10.7 | 1.5 | 12.4 | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | | 1.5 | 4.8 | 9.5 | 1.5 | 12.0 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.5 | 3.7 | 8.5 | 1.5 | 11.0 | ns |
| t_{dis} | disable time | nOE to nAn, nBn; see Figure 6 | [1] | | | | | | |
| | | V _{CC} = 1.2 V | | - | 12.0 | - | - | - | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 2.9 | 5.5 | 12.3 | 2.9 | 14.2 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 1.0 | 3.1 | 7.1 | 1.0 | 8.2 | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | | 1.5 | 3.9 | 8.0 | 1.5 | 10.0 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.7 | 3.6 | 7.0 | 1.7 | 9.0 | ns |
| t _{sk(o)} | output skew time | | [3] | - | - | 1.0 | - | 1.5 | ns |
| C_{PD} | power | per input; $V_I = GND$ to V_{CC} | <u>[4]</u> | | | | | | |
| | dissipation capacitance | V _{CC} = 1.65 V to 1.95 V | | - | 7.7 | - | - | - | pF |
| | capacitatice | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | - | 11.3 | - | - | - | pF |
| | | V _{CC} = 3.0 V to 3.6 V | | - | 14.4 | - | - | - | pF |

^[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

 t_{en} is the same as t_{PZL} and $t_{\text{PZH}}.$

 $t_{\mbox{\scriptsize dis}}$ is the same as $t_{\mbox{\scriptsize PLZ}}$ and $t_{\mbox{\scriptsize PHZ}}.$

- [2] Typical values are measured at $T_{amb} = 25$ °C and $V_{CC} = 1.2$ V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.
- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- [4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}{}^2 \times f_o) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

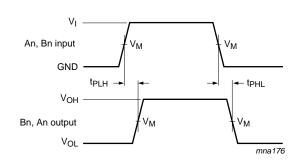
 C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$ = sum of the outputs.

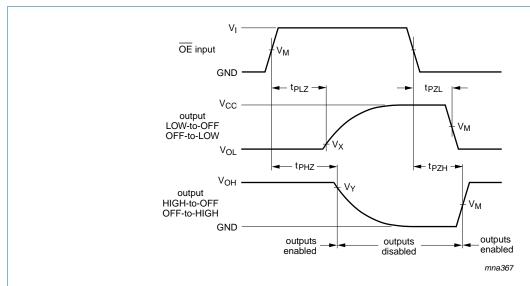
11. AC waveforms



See Table 8 for measurement points

 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 5. Input (An, Bn) to output (Bn, An) propagation delays and output transition times



See Table 8 for measurement points

 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

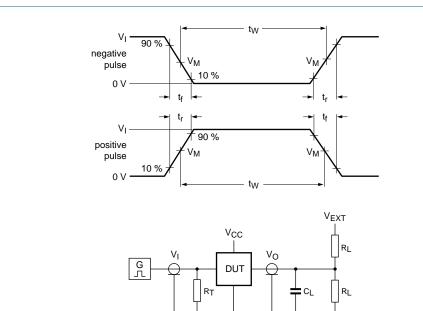
Fig 6. Enable and disable times

Table 8. Measurement points

| Supply voltage | V _M | Input | nput | | | | | | | | |
|------------------|---------------------|----------|-------------|--------------------|------------------|--|--|--|--|--|--|
| V _{CC} | | VI | $t_r = t_f$ | V _X | V _Y | | | | | | |
| 1.2 V | $0.5 \times V_{CC}$ | V_{CC} | ≤ 2.5 ns | $V_{OL} + 0.15 V$ | $V_{OH}-0.15~V$ | | | | | | |
| 1.65 V to 1.95 V | $0.5 \times V_{CC}$ | V_{CC} | ≤ 2.5 ns | $V_{OL} + 0.15 V$ | $V_{OH}-0.15\ V$ | | | | | | |
| 2.3 V to 2.7 V | $0.5 \times V_{CC}$ | V_{CC} | ≤ 2.5 ns | $V_{OL} + 0.15 V$ | $V_{OH}-0.15\ V$ | | | | | | |
| 2.7 V | 1.5 V | 2.7 V | ≤ 2.5 ns | V_{OL} + 0.3 V | $V_{OH} - 0.3 V$ | | | | | | |
| 3.0 V to 3.6 V | 1.5 V | 2.7 V | ≤ 2.5 ns | V_{OL} + 0.3 V | $V_{OH} - 0.3 V$ | | | | | | |

001aae331

Octal bus transceiver; 3-state



Test data is given in Table 9.

Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Fig 7. Test circuit for measuring switching times

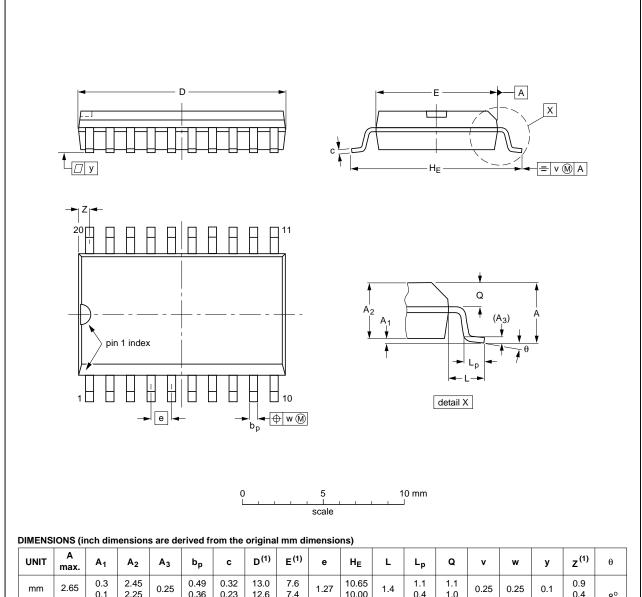
Table 9. Test data

| Supply voltage | Input | | Load | | V _{EXT} | V _{EXT} | | | |
|------------------|----------|---------------------------------|-------|--------------|-------------------------------------|--------------------|-------------------------------------|--|--|
| | VI | t _r , t _f | CL | R_L | t _{PLH} , t _{PHL} | t_{PLZ}, t_{PZL} | t _{PHZ} , t _{PZH} | | |
| 1.2 V | V_{CC} | ≤ 2 ns | 30 pF | 1 k Ω | open | $2\times V_{CC}$ | GND | | |
| 1.65 V to 1.95 V | V_{CC} | ≤ 2 ns | 30 pF | 1 kΩ | open | $2\times V_{CC}$ | GND | | |
| 2.3 V to 2.7 V | V_{CC} | ≤ 2 ns | 30 pF | 500Ω | open | $2\times V_{CC}$ | GND | | |
| 2.7 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500Ω | open | $2\times V_{CC}$ | GND | | |
| 3.0 V to 3.6 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500Ω | open | $2\times V_{CC}$ | GND | | |

12. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



| UNIT | max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | L | Lp | Q | v | w | у | z ⁽¹⁾ | θ |
|--------|------|----------------|----------------|----------------|----------------|----------------|------------------|------------------|------|----------------|-------|----------------|----------------|------|------|-------|------------------|----|
| mm | 2.65 | 0.3 0.1 | 2.45 2.25 | 0.25 | 0.49 0.36 | 0.32 0.23 | 13.0 12.6 | 7.6 7.4 | 1.27 | 10.65 10.00 | 1.4 | 1.1 0.4 | 1.1 1.0 | 0.25 | 0.25 | 0.1 | 0.9 0.4 | 8° |
| inches | 0.1 | 0.012 0.004 | 0.096 0.089 | 0.01 | 0.019 0.014 | 0.013 0.009 | 0.51 0.49 | 0.30 0.29 | 0.05 | 0.419 0.394 | 0.055 | 0.043 0.016 | 0.043 0.039 | 0.01 | 0.01 | 0.004 | 0.035 0.016 | 0° |

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE | | EUROPEAN | ISSUE DATE | | | |
|----------|--------|-------------|------------|--|------------|---------------------------------|
| VERSION | IEC | JEDEC JEITA | | | PROJECTION | ISSUE DATE |
| SOT163-1 | 075E04 | MS-013 | | | | 99-12-27 03-02-19 |

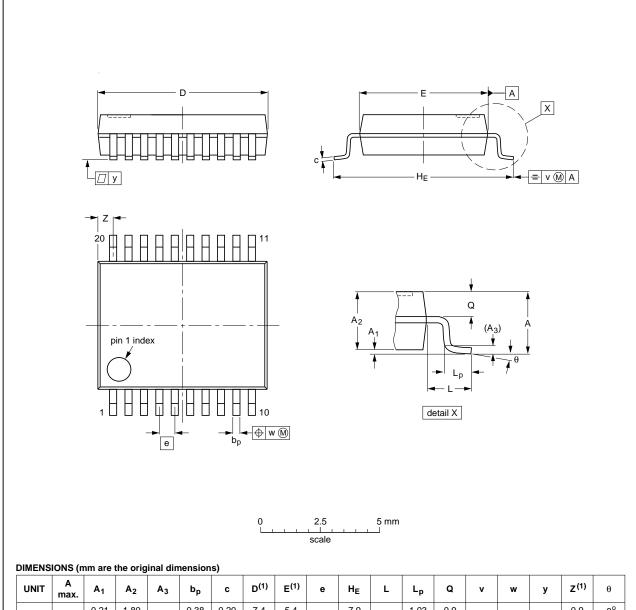
Fig 8. Package outline SOT163-1 (SO20)

74LVC_LVCH245A

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SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|----------------|--------------|--------------|------------------|------------------|------|------------|------|--------------|------------|-----|------|-----|------------------|----------|
| mm | 2 | 0.21 0.05 | 1.80 1.65 | 0.25 | 0.38 0.25 | 0.20 0.09 | 7.4 7.0 | 5.4 5.2 | 0.65 | 7.9 7.6 | 1.25 | 1.03 0.63 | 0.9 0.7 | 0.2 | 0.13 | 0.1 | 0.9 0.5 | 8° 0° |

Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | | |
|----------|-----|--------|----------|------------|------------|---------------------------------|--|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE | |
| SOT339-1 | | MO-150 | | | | 99-12-27 03-02-19 | |

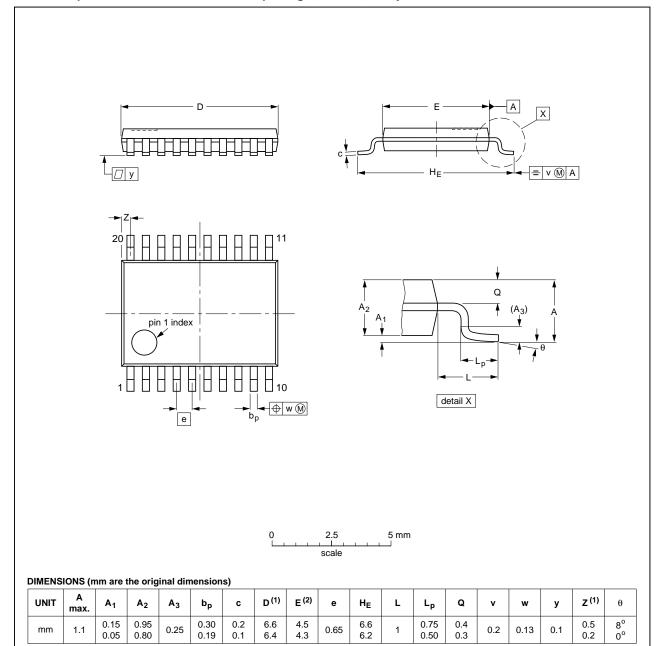
Fig 9. Package outline SOT339-1 (SSOP20)

74LVC_LVCH245A

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TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | | |
|----------|-----|--------|----------|------------|------------|---------------------------------|--|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE | |
| SOT360-1 | | MO-153 | | | | 99-12-27 03-02-19 | |
| | | | | | | | |

Fig 10. Package outline SOT360-1 (TSSOP20)

74LVC_LVCH245A

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DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

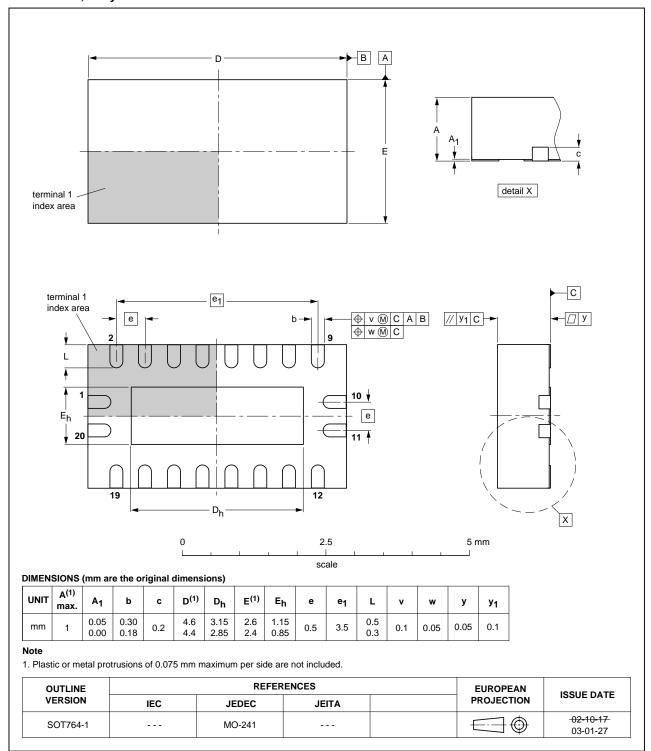


Fig 11. Package outline SOT764-1 (DHVQFN20)

74LVC_LVCH245A All information provide

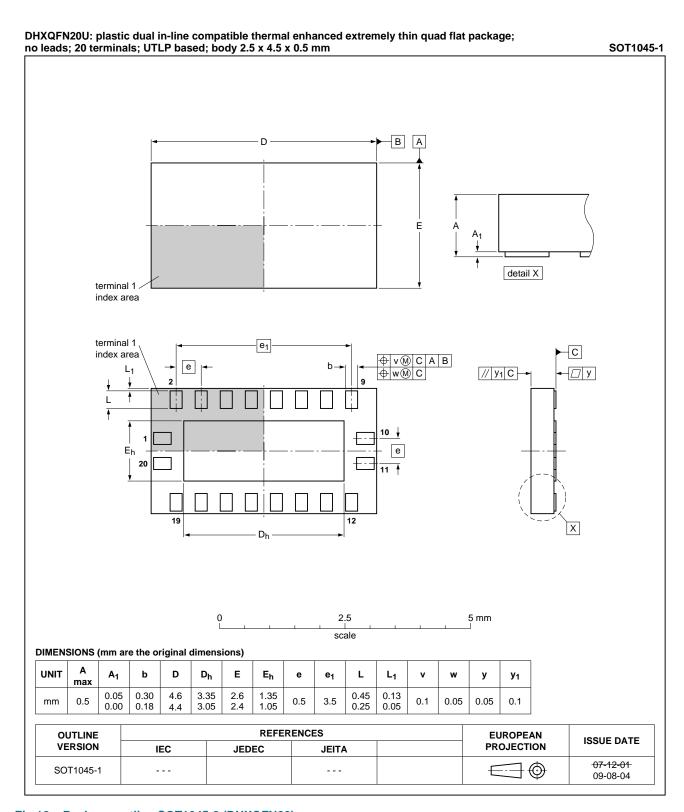


Fig 12. Package outline SOT1045-2 (DHXQFN20)

74LVC_LVCH245A

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13. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|---|
| CDM | Charged Device Model |
| CMOS | Complementary Metal Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

14. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|--------------------------|------------------------------------|---|-----------------------------|---------------------------------|
| 74LVC_LVCH245A v.8 | 20130628 | Product data sheet | - | 74LVC_LVCH245A v.7 |
| Modifications: | | numbers 74LVC245ABX a ged to DHXQFN20 (SOT | | (DHXQFN20U (SOT1045-1) |
| 74LVC_LVCH245A v.7 | 20120405 | Product data sheet | - | 74LVC_LVCH245A v.6 |
| Modifications: | <u>Table note</u> | e 4 of Table 6: corrected (| (errata) | |
| 74LVC_LVCH245A v.6 | 20111125 | Product data sheet | - | 74LVC_LVCH245A v.5 |
| Modifications: | • <u>Table 4, Table 4, Table 1</u> | able 5, <u>Table 6, Table 7,</u> a | and <u>Table 9</u> : values | added for lower voltage ranges. |
| 74LVC_LVCH245A v.5 | 20090825 | Product data sheet | - | 74LVC_LVCH245A v.4 |
| 74LVC_LVCH245A v.4 | 20090703 | Product data sheet | - | 74LVC_LVCH245A v.3 |
| 74LVC_LVCH245A v.3 | 20030507 | Product specification | - | 74LVC245A_74LVCH245A v.2 |
| 74LVC245A_74LVCH245A v.2 | 20020620 | Product specification | - | 74LVC245A_74LVCH245A v.1 |
| 74LVC245A_74LVCH245A v.1 | 19971219 | Product specification | - | - |
| | | | | |

15. Legal information

15.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Octal bus transceiver; 3-state

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